



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE STATEMENT

APPLICANTS: Nakamura et al. ATTORNEY DOCKET NO: P97,0322
SERIAL NO.: 08/809,463 GROUP ART UNIT: ~~2814~~
FILED: April 21, 1997 EXAMINER: N. Kelley
TITLE: "MULTI-LAYERED STRUCTURE FOR FABRICATING AN OHMIC ELECTRODE AND OHMIC ELECTRODE"

Hon. Asst. Commissioner for Patents,
Washington, D.C. 20231

S I R:

In accordance with the provisions of 37 C.F.R. § 1.56, Applicants request that citation and examination of the following documents be made during the course of examination of the above-referenced application for United States Letters Patent. These references are hereby submitted within three months of the date of the European Search Report for the corresponding Singapore Patent Application and additionally these documents are submitted prior to receipt of a First Official Action for this case, thus no fee is due in accordance with the provisions of 37 C.F.R. §1.97(b)(3).

U.S. DOCUMENTS

<u>REFERENCE</u>	<u>U.S. PATENT NO.</u>	<u>PATENTEE</u>	<u>ISSUE DATE</u>
AA	5,027,187	O'Mara, Jr. et al.	June 25, 1991

FOREIGN DOCUMENTS

<u>REFERENCE</u>	<u>DOCUMENT NO.</u>	<u>COUNTRY</u>	<u>PUBLICATION DATE</u>
AL	0 559 182 A2	Europe	September 8, 1993
AM	0 649 167 A2	Europe	April 19, 1995

RECEIVED

NOV 25 1998

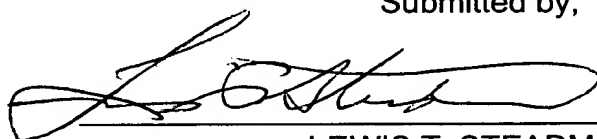
GROUP 2100

P2814 #11
IDS
12/1/98
Tla

EXPLANATION OF RELEVANCE

A copy of the above-identified references together with PTO Form 1449 are submitted herewith. A copy of the Search Report is also enclosed. Applicants submit all claims of the application are patentably distinguishable over the teaching of the above-references, taken alone or in combination. Early consideration of the application is therefore requested.

Submitted by,

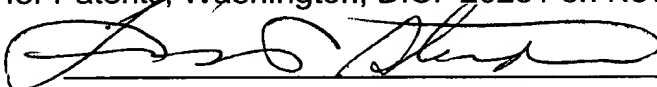


(Reg. 17,074)

LEWIS T. STEADMAN
HILL & SIMPSON
A Professional Corporation
85th Floor - Sears Tower
Chicago, Illinois 60606
Telephone: 312/876-0200 - Ext. 3191
Attorneys for Applicants

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class mail in an envelope addressed to: Hon. Assistant Commissioner for Patents, Washington, D.C. 20231 on November 18, 1998.



LEWIS T. STEADMAN

RECEIVED
NOV 25 1998
GROUP 2100